

v00.0710



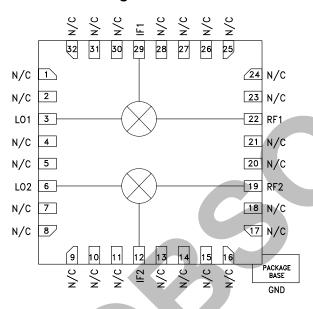
GaAs MMIC SMT DOUBLE-BALANCED DUAL MIXER, 1.7 - 4.5 GHz

Typical Applications

The HMC340ALP5 / HMC340ALP5E Dual Mixer is ideal for:

- Wireless Infrastructure
- Wireless Local Loop
- Image Reject Mixer
- I/Q Modulator
- SSB Modulator

Functional Diagram



Features

Conversion Loss: 8.0 dB LO/RF Isolation: 45 dB LO/IF Isolation: 33 dB Input IP3: +20 dBm

Conversion Gain Balance: 0.1 dB 32 Lead 5x5mm SMT Package: 25mm²

General Description

The HMC340ALP5(E) is a double balanced dual mixer covering 1.7 - 4.5 GHz RF/LO range. This passive MMIC mixer is constructed of GaAs Schottky diodes and on-chip baluns. The device can be used as an upconverter, downconverter, bi-phase (de)modulator, or phase comparator. The mixer symmetry of the HMC340ALP5(E) make it ideal for combining with external hybrids to implement a single sideband upconverter or image reject downconverter assembly. The consistent MMIC performance will improve system operation and assure regulatory compliance. A RoHS compliant, leadless 5x5 mm QFN surface mount package (LP5) houses the dual MMIC mixer IC.

Electrical Specifications, $T_A = +25^{\circ}$ C, As a Function of LO Drive

Parameter	LO = +13 dBm IF = 100 MHz					Units	
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Frequency Range, RF & LO		1.7 - 4.5			3.4 - 3.8		GHz
Frequency Range, IF	DC - 1.5			DC - 1.5	GHz		
Conversion Loss		8	10		8	10	dB
Conversion Gain Amplitude Balance		0.10	0.25		0.10	0.25	dB
Noise Figure (SSB)		8	10		8	10	dB
LO to RF Isolation	30	45		40	47		dB
LO to IF Isolation	25	33		33	38		dB
IP3 (Input)		20			23		dBm
1 dB Gain Compression (Input)		12			13		dBm

^{*} Unless otherwise noted, all measurements performed as single channel downconverter.

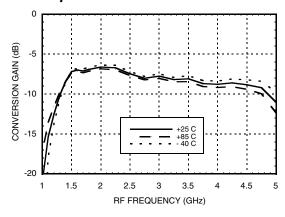


v00.0710

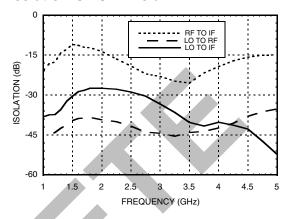


GaAs MMIC SMT DOUBLE-BALANCED DUAL MIXER, 1.7 - 4.5 GHz

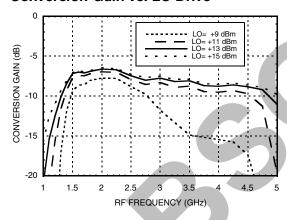
Single Channel: Conversion Gain vs. Temperature @ LO = +13 dBm



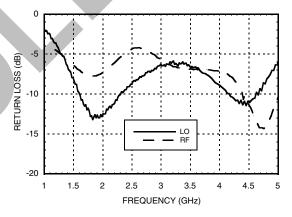
Single Channel: Isolation @ LO = +13 dBm



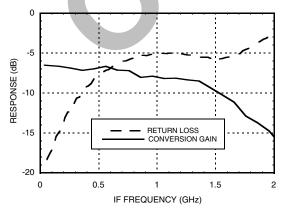
Single Channel: Conversion Gain vs. LO Drive



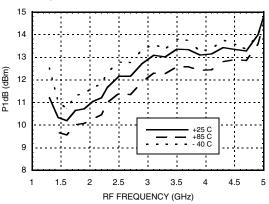
Single Channel: Return Loss @ LO = +13 dBm



Single Channel: IF Bandwidth @ LO = +13 dBm



Single Channel: Input P1dB vs. Temperature @ LO = +13 dBm



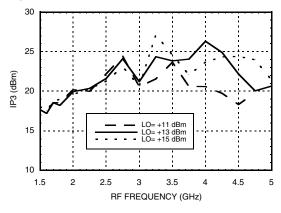


v00.0710

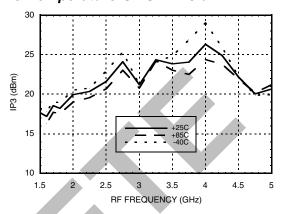


GaAs MMIC SMT DOUBLE-BALANCED DUAL MIXER, 1.7 - 4.5 GHz

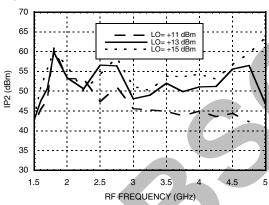
Single Channel: Input IP3 vs. LO Drive



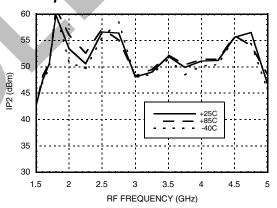
Single Channel: Input IP3 vs. Temperature @ LO = +13 dBm



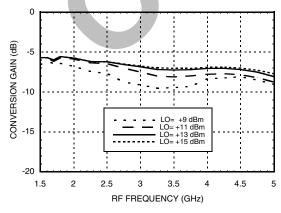
Single Channel: Input IP2 vs. LO Drive



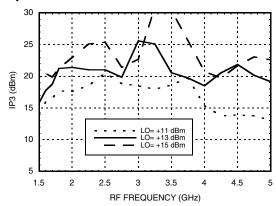
Single Channel: Input IP2 vs. Temperature @ LO = +13 dBm



Single Channel: Upconverter Conversion Gain vs. LO Drive



Single Channel: Upconverter IP3 vs. LO Drive



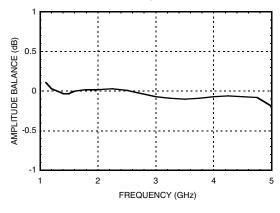


v00.0710

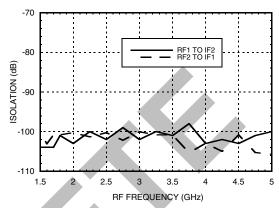


GaAs MMIC SMT DOUBLE-BALANCED DUAL MIXER, 1.7 - 4.5 GHz

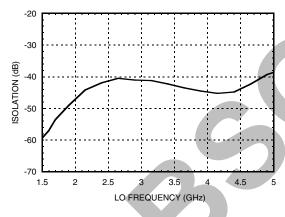
Dual Channel: Conversion Gain Amplitude Balance



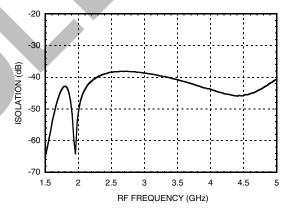
Dual Channel: Channel to Channel Isolation



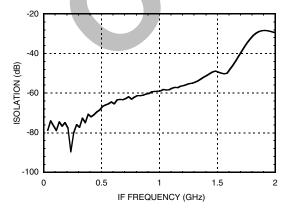
Dual Channel: LO1 to LO2 Isolation



Dual Channel: RF1 to RF2 Isolation



Dual Channel: IF1 to IF2 Isolation



Harmonics of LO

LO Frog (CHz)	nLO Spur at RF Port					
LO Freq. (GHz)	1	2	3	4		
1.5	39	29	57	68		
2.0	40	26	63	68		
2.5	43	28	41	63		
3.0	44	38	63	67		
3.5	44	48	66	70		
4.0 42 49 63 67						
4.5	38	49	63	83		
5.0	36	53	59	89		
LO = +13 dBm						

Values in dBc below input LO level measured at RF Port.



v00.0710



GaAs MMIC SMT DOUBLE-BALANCED DUAL MIXER, 1.7 - 4.5 GHz

Absolute Maximum Ratings

RF / IF Input	+13 dBm
LO Drive	+27 dBm
Channel Temperature	150°C
Continuous Pdiss (T = 85°C) (derate 16.55 mW/°C above 85°C)	1.07 W
Thermal Resistance (R _{TH}) (junction to package base)	60.4 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 deg °C

MxN Spurious Outputs

	nLO				
mRF	0	1	2	3	4
0	xx	11	20	36	45
1	19	0	26	37	41
2	71	67	67	68	71
3	86	86	85	78	78
4	86	86	86	86	86

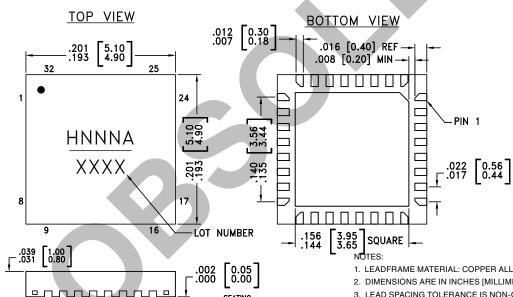
RF = 3.5 GHz @ -10 dBm LO = 3.6 GHz @ +13 dBm

All values in dBc below IF power level



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**

Outline Drawing



PLANE

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

△ .003[0.08] C

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC340ALP5	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H340A XXXX
HMC340ALP5E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H340A XXXX

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX



v00.0710



GaAs MMIC SMT DOUBLE-BALANCED DUAL MIXER, 1.7 - 4.5 GHz

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 2, 4, 5, 7-11, 13-18, 20, 21, 23-28, 30-32	N/C	No Connection. These pins may be connected to RF ground without affecting performance.	
3, 6	LO1, LO2	LO Port: This pin is DC coupled and matched to 50 Ohms.	L01, 0 L02
12, 29	IF2, IF1	IF Port: This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose values has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 4mA of current or die non-function and possible die failure will result.	F2',0
19, 22	RF2, RF1	RF Port: This pin is DC coupled and matched to 50 Ohms.	RF2, ORF1
Package Bottom	GND	Package bottom must be connect to RF/DC ground.	○ GND =



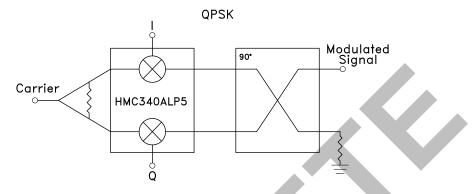


v00.0710

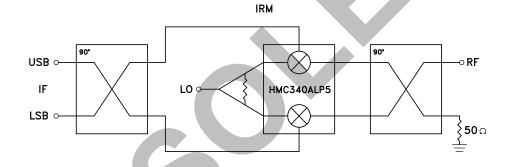


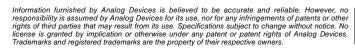
GaAs MMIC SMT DOUBLE-BALANCED DUAL MIXER, 1.7 - 4.5 GHz

Application Circuit for use as an I/Q Modulator



Application Circuit for use as an IRM Mixer





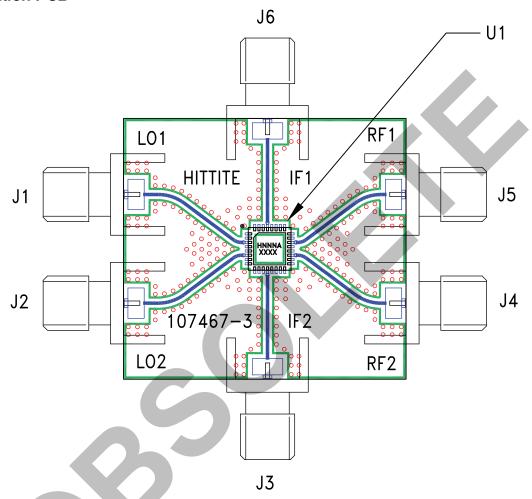


v00.0710



GaAs MMIC SMT DOUBLE-BALANCED DUAL MIXER, 1.7 - 4.5 GHz

Evaluation PCB



List of Materials for Evaluation PCB 107482 [1]

Item	Description
J1 - J6	PCB Mount SMA RF Connector
U1	HMC340ALP5(E) Dual Mixer
PCB [2]	107467 Evaluation Board

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350